

SPECIFICATIONS

Housing: Thermoplastic (UL94 V-0)

Tin Plating On Solder Tail.

Current Rating: 0.5A Max.

Insulation Resistance: 1000 Megohms Min. At DC 500V

Contact Resistance: 50 milliohms Max.

Durability: 5000 Cycles

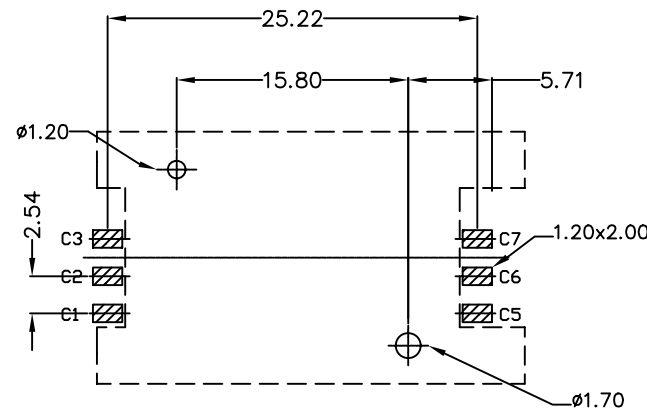
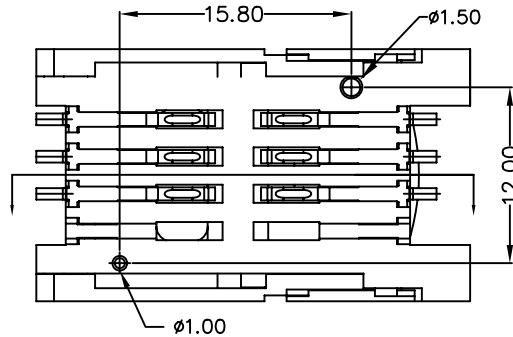
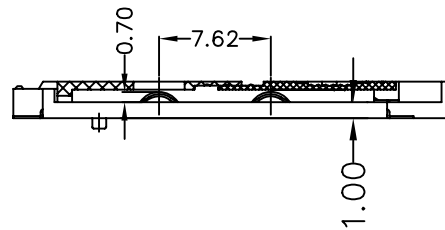
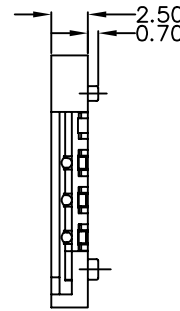
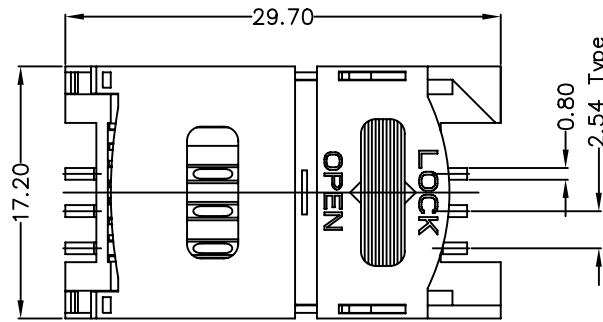
Manual Soldering: 360°C,

Vapor Phase :215°C, 30Sec Max.

IR Reflow: 260°C, 15Sec Max.

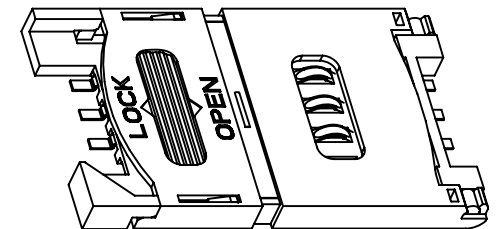
Operation Temperature: -25°C To +85°C

RoHS Compliant



(.XX±0.05)

REFERENCE PCB LAYOUT



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DRAWING No.		APPROVED BY		UNLESS OTHERWISE SPECIFIED TOLERANCES ARE .X ±0.38 .XX ±0.25 ANG. ±1°	NO. REV.	A0	NEW RELEASE REVISIONS	XSH	01/04/2006
		MEI							
		CHECKED BY							
DRAWING BY		LHC		UNIT	mm	A0	XSH	DATE	
XSH									
SCALE	NONE	REV.	A0						
				UNIT		A0		01/04/2006	
				mm		XSH		DATE	